

# ENGINEERING DUAL DEGREE PROGRAM

*Two Universities. Two Degrees. One Program.*

## HIGHLIGHTS

Two bachelor's degrees —  
Butler University & Purdue University

Highly integrated science and  
engineering curriculum

Five year program, concurrent enrollment  
at both institutions

ABET accredited engineering degrees

Established 1999 with 165+ graduates to date

100% Placement Rate



## BY THE NUMBERS

3.1  
AVERAGE  
GPA

100%  
INTERNSHIP  
EXPERIENCE

100%  
PLACEMENT  
RATE

26% GRADUATE  
WITH UNIVERSITY  
HONORS

## PROGRAM COMBINATIONS

- Biology
- Chemistry
- Computer Science
- Economics
- Math
- Physics
- Science, Technology & Society
- Biomedical Engineering
- Computer Engineering
- Electrical Engineering
- Energy Engineering
- Mechanical Engineering
- Motorsports Engineering

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## TYPICAL FIRST YEAR

### Fall (around 16 Credits)

DD190 Engineering	(3 cr)
FYS101 Writing/Speaking	(3 cr)
MA106 Calculus 1	(5 cr)
CH105 Chemistry 1	
<i>or</i>	(5 cr)
PH201 Physics 1	
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	16 Credits

### Spring (around 15 Credits)

CS142 Programming	(3 cr)
FYS102 Writing/Speaking	(3 cr)
MA107 Calculus 2	(4 cr)
CH106 Chemistry 2	
<i>or</i>	(5 cr)
PH202 Physics 2	
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	15 Credits

## FACTS

- 160 students in the program, with incoming class of 45 each year.
- Application, financial aid, and housing managed by Butler.
- Three semesters to identify majors within the program.
- Engineering classes normally taught at Butler for first three years.
- Students carpool between campuses (approx. 15 minutes) during last two years.
- Required Internship with diverse educational experiences leading to a wide range of career opportunities.
- Access to three career centers, (Butler, IUPUI and Purdue at West Lafayette).
- Active Engineering Dual Degree Club and access to student membership for a number of Professional Engineering Organizations.

## WHERE OUR INTERNS AND GRADS WORK

- |                     |                     |                    |
|---------------------|---------------------|--------------------|
| • Anheuser-Busch    | • FBI               | • NASA             |
| • BidPal            | • Google            | • Phoenix Contact  |
| • Boeing            | • Helmer            | • Raytheon         |
| • Boston Scientific | • Hill-Rom          | • Rolls-Royce      |
| • Chevron           | • Indianapolis      | • SAIC             |
| • Chrysler          | Power & Light       | • Sandia Nat'l Lab |
| • CIA               | • Intel             | • Shell Oil        |
| • Cook Medical      | • Interactive       | • Siemens          |
| • Cummins           | Intelligence        | • Stryker          |
| • Eli Lilly         | • L3 Communications | • Trane            |
| • Emerson           | • Lockheed Martin   | • Zimmer           |
| Electronic          | • Midwest ISO       |                    |



## PROGRAM CONTACT INFORMATION

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